

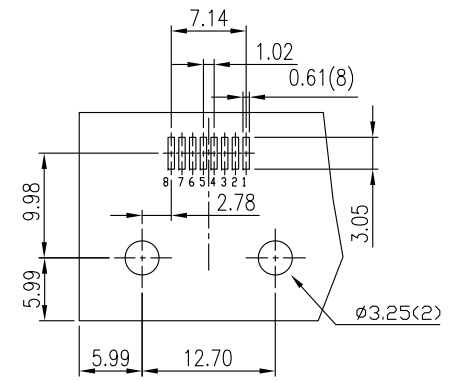
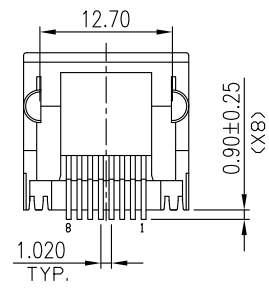
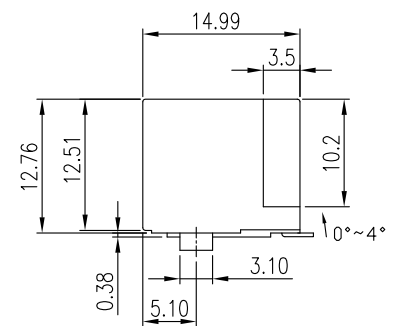
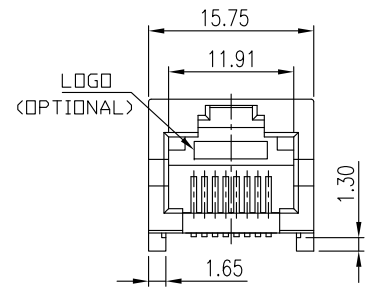
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The marking on this product doesn't contain environmental hazardous materials per Material Specification 55-00259 for Sony GP compliant or per directive 2002/95/EC for RoHS compliant.

REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
AX1		NON-RELEASE REVISION	11/05/2009	Arron Lin

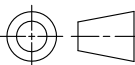
**PRELIMINARY RELEASE
SUBJECT TO CHANGE**

- NOTES:
- MATERIAL:
 - HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, NYLON 9T, UL94V-0, COLOR: BLACK.
 - INSERT HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, NYLON 46, UL94V-0, COLOR: BLACK.
 - TERMINAL: PHOSPHOR BRONZE.
 - FINISH:
 - TERMINAL:
 - CONTACT AREA: SELECTED GOLD PLATING;
 - SOLDERING AREA: WITH HARD GOLD AND GOLD FLASH.
 - UNDER PLATING: NICKEL PLATING 50 μ" THICKNESS MIN. OVERALL.
 - PACKING IS PER AMTA PACKING SPECIFICATION PKS-0001.
 - THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS PER DIRECTIVE 2002/95/EC FOR RoHS COMPLIANT.



PCB LAYOUT
Ref.

G71B0247400EU	50u"
G71B0247300EU	30u"
G71B0247200EU	15u"
G71B0247100EU	6u"
G71B0247000EU	G/F
PART NUMBER	FINISH

TOLERANCE		APPROVALS		DATE	TITLE		Amphenol®			
X.		DRAWN	Daniel Hsieh	11/05/2009	G71B SERIES MODULAR JACK 8P8C, R/A, SIDE ENTRY, SMT TYPE		Amphenol Corporation Amphenol Taiwan Corporation			
X.X	±0.30	CHECKED	Roger Tsai	11/05/2009						
X.XX	±0.20	APPROVED	Arron Lin	11/05/2009						
X.XXX	±0.10						UNIT	mm	SIZE	A3
ANGULAR	±1°						SCALE	NA	SHEET	1 OF 1
UNLESS OTHERWISE SPECIFIED		DWG TYPE		PROJECT CODE			PART No.		G71B0247X00EU	
		CUST DWG		MJK			DWG No.		G71B0247X00EU	